	© Co	terial Compo pyright 2005. IPC, Bannoc International and Pan-Americ	kburn, Illinois	All rights reserve	tion with lower	level p	arts, the	declaratior	n encor	mpasses a	all lower l	evel mate	rials for	which t	e item is an assembly ne manufacturer has leclaration.
1/32-2 1.1		Web Site for Informat //www.ipc.org/IPC-1		-1752 Standa					ation Class * 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat						
Supplier Information															
Company Name * Company Unique ID				Unique ID Au	Response Date *				Response Document ID						
SEMTECH CORPORATION 00-847-9941		00-847-9941	DUNS				)3-18								
Contact Name * Roya Motamedi		Title - Contact QA Customer Service Specialis				Email - Contact * rmotamedi@semtech.			om	Duplicate Contact -> Authorized Representative					
Authorized Representative *Title - RepresRoya MotamediQA Customer				Phone - Representative * Specialis805-389-2742			Email - Representative * rmotamedi@semtech.com			Supplier	Commen	ts or URL	for Add	litional li	nformation
Requester Item Number		Mfr Item Number		Mfr Item Name	Effectiv	Version	on Manufacturin		e V	Veight *	UC	M	Unit Type		
		UClamp3601P.TNT		TVS Diode fo	r Proximity Switch						0.911		mg	g	Each
Alternate Recommenda	ation				Alternate Item			Item Co	omments					•	
Manufacturing Proces	ss In	formation													
Terminal Plating / Grid Array I	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	iting	Peak Proc	ess Body	Temper	rature Max	k Time at F	Peak Temp	erature	Number	of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy				2			2 <b>60</b> C	0 C		30 seconds		3			
Comments UClamp3601P.TNT is RE	ACH	-compliant product,	per EU R	egulation EC	1907/2006 to incl	ude re	cent add	ition of S	VHC o	andidate	list of s	ubstance	es in De	cember	2013.

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields						
<b>RoHS Materia</b>	RoHS Material Composition Declaration Declaration Declaration Type * Detailed												
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),						
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided						
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted						
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration						
Declaration S	ignature												
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars						

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exampt		Unit of Measure	Toleran	ce PPM
	Name		Material	weight	Measure		Level	Substance Category			Substance	CAS	Exempt				- FFIVI
+I -I	Die	+M -M	Doped Silicon	0.0447	mg	+C -0	Supplier		+S	-S	Si	7440-21-3		0.0447	mg		49,038
+  -	Leadframe	+M -M	C7025 SLP1006F	0.358599	mg	+C -(	Supplier		+S	-S	Cu	7440-50-8		0.3439	mg		377,37
		_							+S	-s	Si	7440-21-3		0.0026	mg		2,853
						+C -(	В	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0115	mg		12,592
						+C -(	Supplier		+S	-s	Mg	7439-95-4		0.0006	mg		689
		+M -M	NiPdAu plating	0.00919	mg	+C -(	В		+S	-s	Nickel	7440-02-0		0.0083	mg		9,098
						+C -(	Supplier	middle plating	+S	-S	Pd	7440-05-3		0.0008	mg		827
						+C -(	Supplier	outer plating	+S	-s	Au	7440-57-5		0.0001	mg		164
+  -	Bonding wire	+M -M	Gold	0.0075	mg	+C -(	Supplier		+S	-S	Au	7440-57-5		0.0075	mg		8,246
+  -	Molding compound	+M -M	EME-G770HCD	0.469934	Img	+C -(	Supplier		+S	-s	Silica fused	60676-86-0		0.4394	mg		482,16
							-		+S	-s	Epoxy resin	Proprietary		0.0141	mg		15,470
									+S	-s	Phenol resin	Proprietary		0.0141	mg		15,470
									+S	-s	Carbon Black	1333-86-4		0.0023	mg		2,578
+  -	Die attached Epoxy	/ +M -M	QMI519	0.02136	mg	+C -(	Supplier		+S	-s	Ag	7440-22-4		0.0171	mg		18,751
							-		+S	-s	palladium compound	Proprietary		0.00003	mg		35
									+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000001	mg		1
									+S	-s	Hydroquinone	123-31-9		0.00000	mg		0.02
									+S	-s	Acrylate	Proprietary		0.0034	mg		3,714
									+S	-s	Bismaleimide resin	Proprietary		0.0006	mg		703
									+S	-s	Polymer of polybutadie	Proprietary		0.0002	mg		234